Analog Multiplexers/ Demultiplexers

High-Performance Silicon-Gate CMOS

MC74HC4051A, MC74HC4052A, MC74HC4053A

The MC74HC4051A, MC74HC4052A and MC74HC4053A utilize silicon–gate CMOS technology to achieve fast propagation delays, low ON resistances, and low OFF leakage currents. These analog multiplexers/demultiplexers control analog voltages that may vary across the complete power supply range (from V_{CC} to V_{EE}).

The HC4051A, HC4052A and HC4053A are identical in pinout to the metal-gate MC14051AB, MC14052AB and MC14053AB. The Channel-Select inputs determine which one of the Analog Inputs/Outputs is to be connected, by means of an analog switch, to the Common Output/Input. When the Enable pin is HIGH, all analog switches are turned off.

The Channel–Select and Enable inputs are compatible with standard CMOS outputs; with pullup resistors they are compatible with LSTTL outputs.

These devices have been designed so that the ON resistance (R_{on}) is more linear over input voltage than R_{on} of metal-gate CMOS analog switches.

For a multiplexer/demultiplexer with injection current protection, see HC4851A and HC4852A.

Features

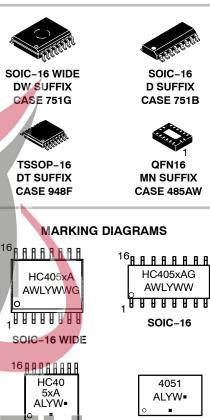
- Fast Switching and Propagation Speeds
- Low Crosstalk Between Switches
- Diode Protection on All Inputs/Outputs
- Analog Power Supply Range ($V_{CC} V_{EE}$) = 2.0 to 12.0 V
- Digital (Control) Power Supply Range ($V_{CC} GND$) = 2.0 to 6.0 V
- Improved Linearity and Lower ON Resistance Than Metal–Gate Counterparts
- Low Noise
- In Compliance with the Requirements of JEDEC Standard No. 7A
- Chip Complexity: HC4051A 184 FETs or 46 Equivalent Gates
 - HC4052A 168 FETs or 42 Equivalent Gates HC4053A – 156 FETs or 39 Equivalent Gates
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR–Free and are RoHS Compliant

This document contains information on some products that are still under development. ON Semiconductor reserves the right to change or discontinue these products without notice.



ON Semiconductor®

www.onsemi.com



QFN16

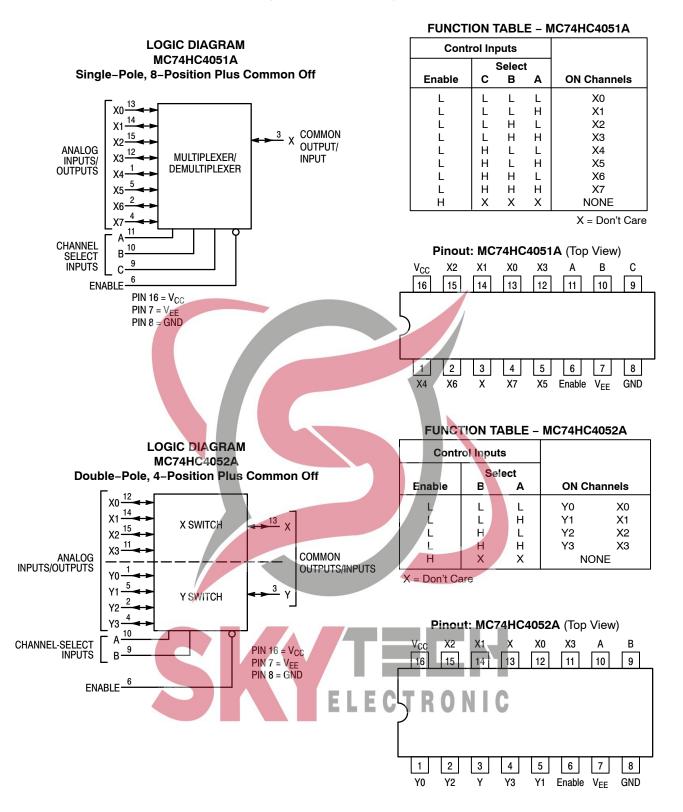
- **TSSOP_16** x = 1, 2 or 3
 - = Assembly Location
- WL, L = Wafer Lot

- YY, Y = Year WW, W = Work Week
- G or = Pb–Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 13 of this data sheet.



FUNCTION TABLE - MC74HC4053A **Control Inputs** LOGIC DIAGRAM MC74HC4053A Select **ON Channels** Enable С в Triple Single-Pole, Double-Position Plus Common Off Α Z0 YO XO L L L L 12 L L L Н Z0 Y0 X1 XO 14 L L н L Z0 Y1 X0 X SWITCH 13 X1 Z0 L Н Н Y1 X1 L L н L L Z1 Y0 X0 L Н L Н Z1 Y0 X1 Y0 15 COMMON ANALOG X0 L Н н Y1 Y SWITCH L Z1 OUTPUTS/INPUTS INPUTS/OUTPUTS L н Н н Z1 Y1 X1 н Х Х Х NONE 5 Z0 **Z SWITCH** 7 X = Don't Care 3 Z1 11 A CHANNEL-SELECT 10 PIN 16 = V_{CC} В INPUTS PIN 7 = V_{EE} Pinout: MC74HC4053A (Top View) 9 С PIN 8 = GND 6 Х X1 X0 В С V_{CC} А ENABLE 16 15 14 12 9 13 11 10 NOTE: This device allows independent control of each switch. Channel-Select Input A controls the X-Switch, Input B controls the Y-Switch and Input C controls the Z-Switch 2 1 3 4 5 6 7 8 YI Y0 Z1 Ζ Z0 Enable V_{EE} GND MAXIMUM RATINGS Symbol Parameter Value Unit This device contains protection circuitry to guard against damage Positive DC Supply Voltage (Referenced to GND) -0.5 to +7.0 ν V_{CC} due to high static voltages or electric (Referenced to VEE) -0.5 to +14.0 fields. However, precautions must Negative DC Supply Voltage (Referenced to GND) V V_{EE} 7.0 to +5.0 be taken to avoid applications of any voltage higher than maximum rated V_{FF} - 0.5 to VIS Analog Input Voltage ν voltages to this high-impedance cir-V_{CC} + 0.5 cuit. For proper operation, Vin and Vout should be constrained to the V_{in} Digital Input Voltage (Referenced to GND) V -0.5 to V_{CC} + 0.5 range GND \leq (V_{in} or V_{out}) \leq V_{CC}. ±25 DC Current, Into or Out of Any Pin mΑ Т Unused inputs must always be tied to an appropriate logic voltage PD Power Dissipation in Still Air, SOIC Packaget mW 500 level (e.g., either GND or V_{CC}). TSSOP Packaget 450 Unused outputs must be left open. T_{stg} Storage Temperature Range -65 to +150 °C Lead Temperature, 1 mm from Case for 10 Seconds °C TL SOIC or TSSOP Package

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

†Derating: SOIC Package: -7 mW/°C from 65° to 125°C

TSSOP Package: -6.1 mW/°C from 65° to 125°C

260

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Max	Unit
V _{CC}	Positive DC Supply Voltage	(Referenced to GND) (Referenced to V _{EE})	2.0 2.0	6.0 12.0	V
V_{EE}	Negative DC Supply Voltage, Output (Referenced to GND)	-6.0	GND	V	
V _{IS}	Analog Input Voltage	V _{EE}	V _{CC}	V	
V _{in}	Digital Input Voltage (Referenced to GND)		GND	V _{CC}	V
V _{IO} *	Static or Dynamic Voltage Across Switch			1.2	V
T _A	Operating Temperature Range, All Package Types		-55	+125	°C
t _r , t _f	Input Rise/Fall Time (Channel Select or Enable Inputs)	V _{CC} = 2.0 V V _{CC} = 3.0 V V _{CC} = 4.5 V V _{CC} = 6.0 V	0 0 0 0	1000 600 500 400	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

*For voltage drops across switch greater than 1.2 V (switch on), excessive V_{CC} current may be drawn; i.e., the current out of the switch may contain both V_{CC} and switch input components. The reliability of the device will be unaffected unless the Maximum Ratings are exceeded.

DC CHARACTERISTICS — Digital Section (Voltages Referenced to GND) VEE = GND, Except Where Noted

			Vcc	Guaranteed Limit			
Symbol	Parameter	Condition	V	–55 to 25°C	≤ 85°C	≤125°C	Unit
V _{IH}	Minimum High-Level Input Voltage, Channel-Select or Enable Inputs	R _{on} /= Per Spec	2.0 3.0 4.5 6.0	1.50 2.10 3.15 4.20	1.50 2.10 3.15 4.20	1.50 2.10 3.15 4.20	V
V _{IL}	Maximum Low-Level Input Voltage, Channel-Select or Enable Inputs	R _{on} = Per Spec	2.0 3.0 4.5 6.0	0.5 0.9 1.35 1.8	0.5 0.9 1.35 1.8	0.5 0.9 1.35 1.8	V
l _{in}	Maximum Input Leakage Current, Channel-Select or Enable Inputs	$V_{in} = V_{CC}$ or GND, $V_{EE} = -6.0 V$	6.0	± 0.1	± 1.0	± 1.0	μΑ
I _{CC}	Maximum Quiescent Supply Current (per Package)	$\label{eq:channel Select, Enable and} \begin{array}{l} \mbox{Channel Select, Enable and} \\ \mbox{V}_{IS} = \mbox{V}_{CC} \mbox{ or GND}; \mbox{V}_{EE} = \mbox{GND} \\ \mbox{V}_{IO} = 0 \mbox{ V} \qquad \mbox{V}_{EE} = - \mbox{ 6.0 } \end{array}$	6.0 6.0	1 4	10 40	20 80	μΑ



DC CHARACTERISTICS — Analog Section

					Guaranteed Limit			
Symbol	Parameter	Condition	Vcc	V _{EE}	–55 to 25°C	≤ 85°C	≤125°C	Unit
R _{on}	Maximum "ON" Resistance		4.5 4.5 6.0	0.0 - 4.5 - 6.0	190 120 100	240 150 125	280 170 140	Ω
			4.5 4.5 6.0	0.0 - 4.5 - 6.0	150 100 80	190 125 100	230 140 115	
ΔR_{on}	Maximum Difference in "ON" Resistance Between Any Two Channels in the Same Package		4.5 4.5 6.0	0.0 - 4.5 - 6.0	30 12 10	35 15 12	40 18 14	Ω
I _{off}	Maximum Off-Channel Leakage Current, Any One Channel		6.0	- 6.0	0.1	0.5	1.0	μΑ
	Maximum Off-ChannelHC4051A Leakage Current, HC4052A Common Channel HC4053A	$V_{IO} = V_{CC} - V_{EE};$	6.0 6.0 6.0	- 6.0 - 6.0 - 6.0	0.2 0.1 0.1	2.0 1.0 1.0	4.0 2.0 2.0	
I _{on}	Maximum On-ChannelHC4051A Leakage Current, HC4052A Channel-to-Channel HC4053A		6.0 6.0 6.0	- 6.0 - 6.0 - 6.0	0.2 0.1 0.1	2.0 1.0 1.0	4.0 2.0 2.0	μΑ

AC CHARACTERISTICS ($C_L = 50$ pF, Input $t_r = t_f = 6$ ns)

			Vcc	Guara	nteed Lim	nit	
Symbol	Parameter		v	-55 to 25°C	≤ 85°C	≤125°C	Unit
t _{PLH} , t _{PHL}	Maximum Propagation Delay, <mark>C</mark> hannel–Select to Analog (Figure 9)		2.0 3.0 4.5 6.0	270 90 59 45	320 110 79 65	350 125 85 75	ns
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Analog Input to Analog Ou (Figure 10)	utput	2.0 3.0 4.5 6.0	40 25 12 10	60 30 15 13	70 32 18 15	ns
t _{PLZ} , t _{PHZ}	Maximum Propagation Delay, Enable to Analog Output (Figure 11)		2.0 3.0 4.5 6.0	160 70 48 39	200 95 63 55	220 110 76 63	ns
t _{PZL} , t _{PZH}	Maximum Propagation Delay, Enable to Analog Output (Figure 11)	T	2.0 3.0 4.5 6.0	245 115 49 39	315 145 69 58	345 155 83 67	ns
C _{in}	Maximum Input Capacitance, Channel-Select or Enable	Inputs		10	10	10	pF
C _{I/O}	Maximum Capacitance	Analog I/O	ΠU	35	35	35	pF
	(All Switches Off) Common O	/l: HC4051A HC4052A HC4053A		130 80 50	130 80 50	130 80 50	
	Fe	eed-through		1.0	1.0	1.0	
		-	Typica	I @ 25°C, V _{CC}	= 5.0 V, V	' _{EE} = 0 V	
C _{PD}	Power Dissipation Capacitance (Figure 13)*	HC4051A HC4052A HC4053A		45 80 45			pF

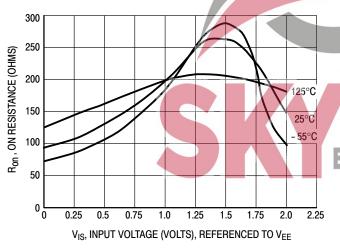
* Used to determine the no–load dynamic power consumption: $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$.

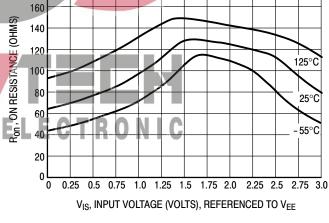
ADDITIONAL APPLICATION CHARACTERISTICS (GND = 0 V)

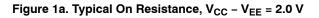
			v _{cc}	V _{EE}	Limit* 25°C		Unit	
Symbol	Parameter	Condition	v	V				
BW	Maximum On-Channel Bandwidth or Minimum Frequency Response (Figure 6)	$ \begin{array}{l} f_{in} = 1 MHz \; Sine \; Wave; \; Adjust \; f_{in} \; Voltage \\ to \; Obtain \; 0dBm \; at \; V_{OS}; \; Increase \; f_{in} \\ Frequency \; Until \; dB \; Meter \; Reads \; -3dB; \\ R_L = 50\Omega, \; C_L = 10 pF \end{array} $	2.25 4.50 6.00	-2.25 -4.50 -6.00	'51 80 80 80	'52 95 95 95	'53 120 120 120	MHz
-	Off-Channel Feed-through Isolation (Figure 7)	$ \begin{array}{l} f_{in} = Sine \mbox{ Wave; Adjust } f_{in} \mbox{ Voltage to} \\ Obtain \mbox{ 0dBm at } V_{IS} \\ f_{in} = 10 \mbox{ Hz, } R_L = 600 \Omega, \mbox{ C}_L = 50 \mbox{ pF} \end{array} $	2.25 4.50 6.00	-2.25 -4.50 -6.00		-50 -50 -50	I	dB
		f _{in} = 1.0MHz, R _L = 50Ω, C _L = 10pF	2.25 4.50 6.00	-2.25 -4.50 -6.00		-40 -40 -40		
-	Feedthrough Noise. Channel-Select Input to Common I/O (Figure 8)	$ \begin{array}{l} V_{in} \leq 1 MHz \; Square \; Wave \; (t_r = t_f = 6ns); \\ Adjust \; R_L \; at \; Setup \; so \; that \; I_S = 0A; \\ Enable = GND \qquad R_L = 600 \Omega, \; C_L = 50 pF \end{array} $	2.25 4.50 6.00	-2.25 -4.50 -6.00		25 105 135		mV _{PP}
		$R_L = 10k\Omega, C_L = 10pF$	2.25 4.50 6.00	-2.25 -4.50 -6.00		35 145 190		
_	Crosstalk Between Any Two Switches (Figure 12) (Test does not apply to HC4051A)	$ f_{in} = \text{Sine Wave; Adjust } f_{in} \text{ Voltage to} \\ Obtain 0dBm at V_{IS} \\ f_{in} = 10kHz, R_L = 600\Omega, C_L = 50pF $	2.25 4.50 6.00	-2.25 -4.50 -6.00		-50 -50 -50		dB
		f _{in} = 1.0MHz, R _L = 50Ω, C _L = 10pF	2.25 4.50 6.00	-2.25 -4.50 -6.00		-60 -60 -60		
THD	Total Harmonic Distortion (Figure 14)	$\label{eq:fin} \begin{array}{l} f_{in} = 1 \text{kHz}, \text{R}_{L} = 10 \text{kQ}, \text{C}_{L} = 50 \text{pF} \\ \text{THD} = \text{THD}_{measured} - \text{THD}_{source} \\ \text{V}_{IS} = 4.0 \text{V}_{Pp} \text{ sine wave} \\ \text{V}_{IS} = 8.0 \text{V}_{Pp} \text{ sine wave} \\ \text{V}_{IS} = 8.0 \text{V}_{Pp} \text{ sine wave} \\ \text{V}_{IS} = 11.0 \text{V}_{Pp} \text{ sine wave} \end{array}$	2.25 4.50 6.00	-2.25 -4.50 -6.00		0.10 0.08 0.05		%

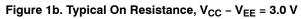
180

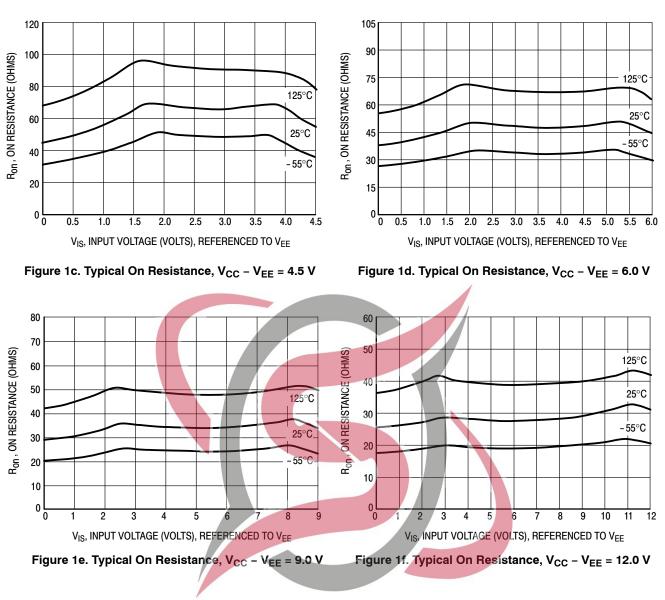
*Limits not tested. Determined by design and verified by qualification.











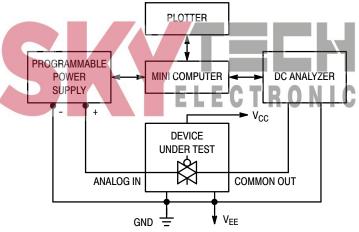
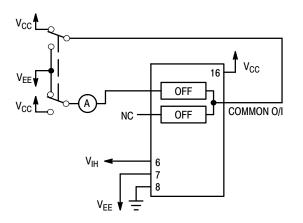
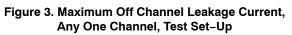
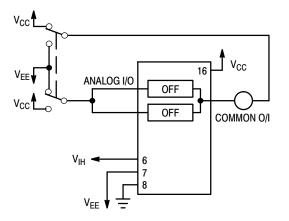
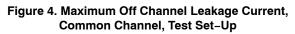


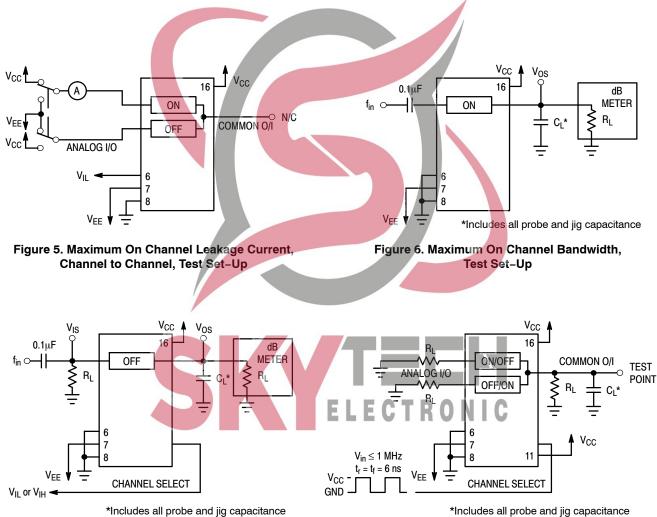
Figure 2. On Resistance Test Set-Up





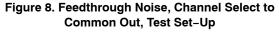


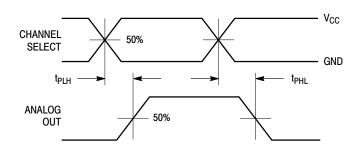




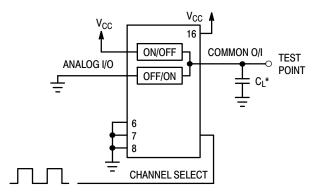


mondee an probe and jig capacitance



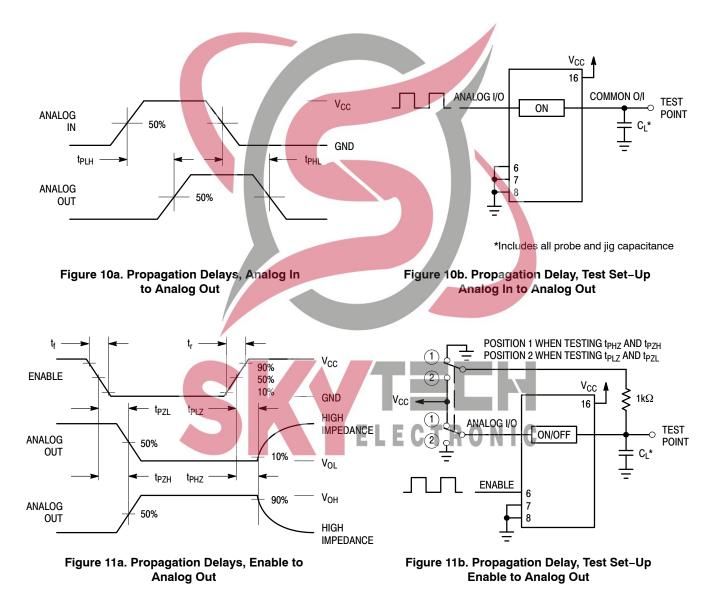


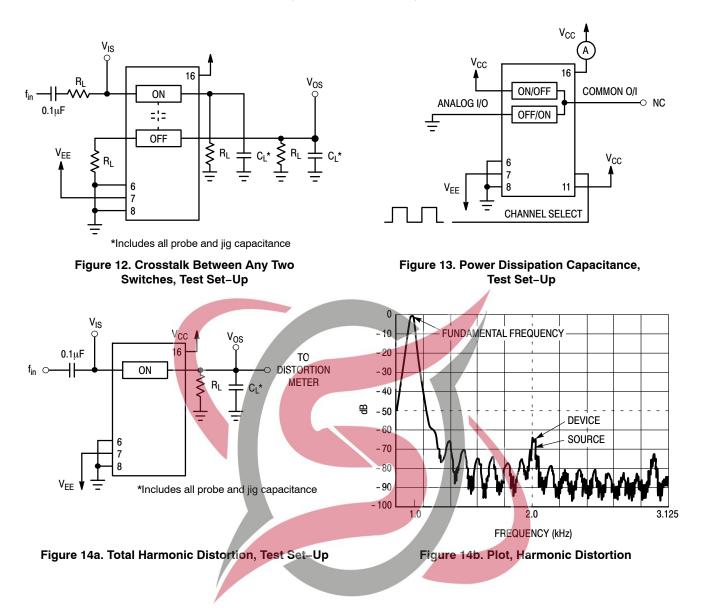




*Includes all probe and jig capacitance







APPLICATIONS INFORMATION

The Channel Select and Enable control pins should be at V_{CC} or GND logic levels. V_{CC} being recognized as a logic high and GND being recognized as a logic low. In this example:

$$V_{CC} = +5V = logic high$$

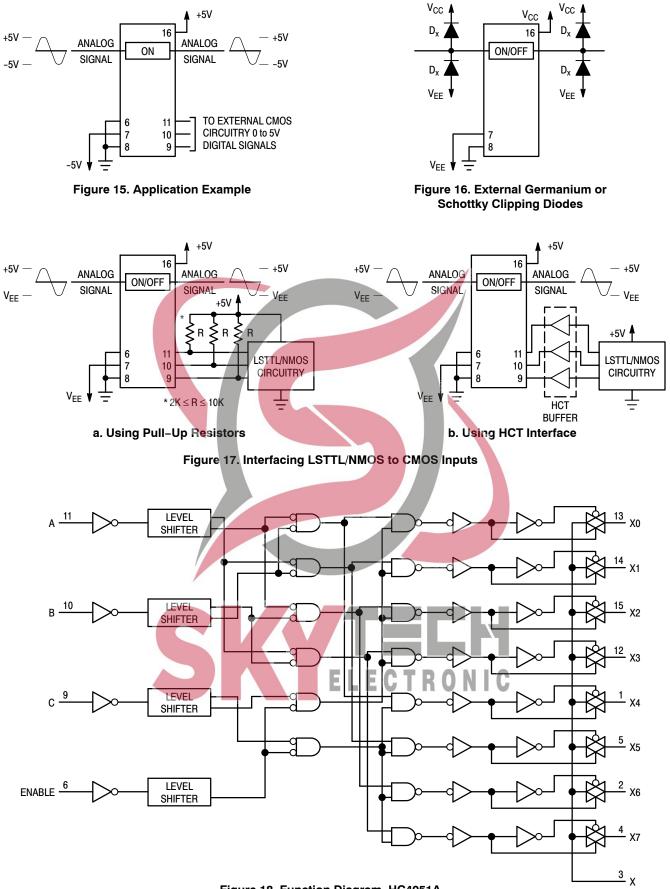
GND = 0V = logic low

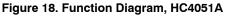
The maximum analog voltage swings are determined by the supply voltages V_{CC} and V_{EE} . The positive peak analog voltage should not exceed V_{CC} . Similarly, the negative peak analog voltage should not go below V_{EE} . In this example, the difference between V_{CC} and V_{EE} is ten volts. Therefore, using the configuration of Figure 15, a maximum analog signal of ten volts peak-to-peak can be controlled. Unused analog inputs/outputs may be left floating (i.e., not connected). However, tying unused analog inputs and outputs to V_{CC} or GND through a low value resistor helps minimize crosstalk and feed-through noise that may be picked up by an unused switch.

Although used here, balanced supplies are not a requirement. The only constraints on the power supplies are that:

$$\begin{split} V_{CC} &- GND = 2 \text{ to } 6 \text{ volts} \\ V_{EE} &- GND = 0 \text{ to } -6 \text{ volts} \\ V_{CC} &- V_{EE} = 2 \text{ to } 12 \text{ volts} \\ \text{ and } V_{EE} \leq GND \end{split}$$

When voltage transients above V_{CC} and/or below V_{EE} are anticipated on the analog channels, external Germanium or Schottky diodes (D_x) are recommended as shown in Figure 16. These diodes should be able to absorb the maximum anticipated current surges during clipping.





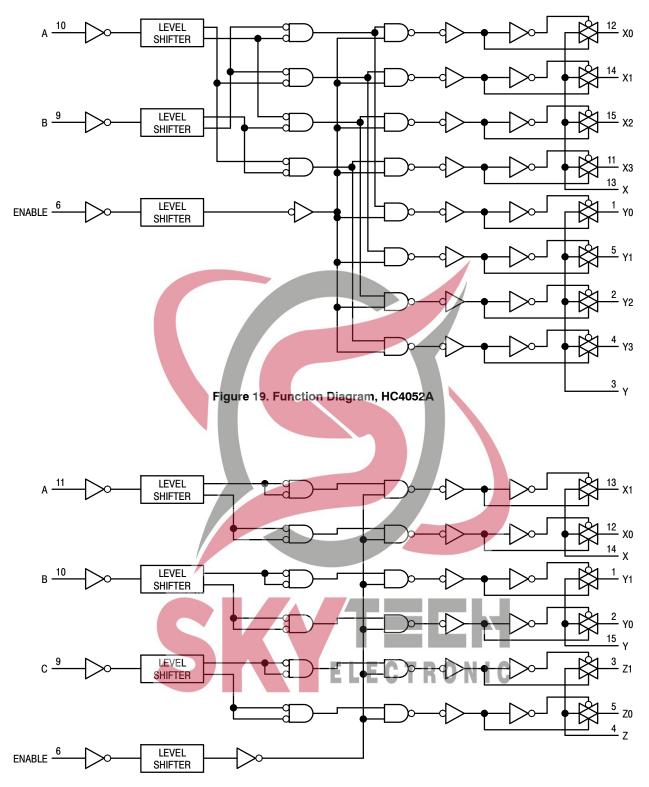


Figure 20. Function Diagram, HC4053A

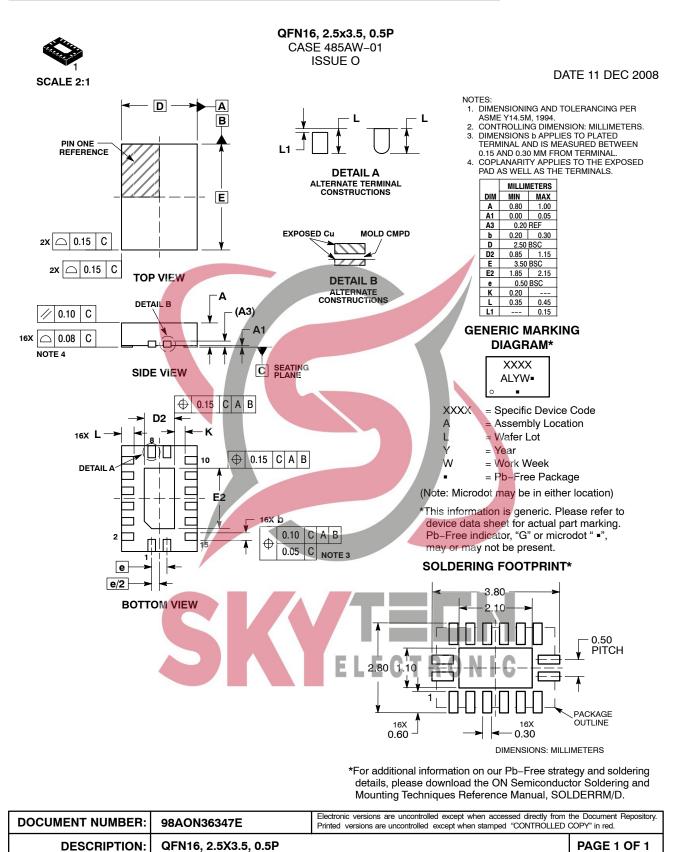
ORDERING INFORMATION

Device	Package	Shipping [†]
MC74HC4051ADG		48 Units / Rail
MC74HC4051ADR2G	SOIC-16	2500 Units / Tape & Reel
NLV74HC4051ADR2G*	(Pb-Free)	2500 Units / Tape & Reel
MC74HC4051AADR2G	7	2500 Units / Tape & Reel
MC74HC4051ADWG		48 Units / Rail
MC74HC4051ADWR2G	SOIC-16 WIDE (Pb-Free)	1000 Units / Tape & Reel
NLVHC4051ADWR2G*		1000 Units / Tape & Reel
MC74HC4051ADTG		96 Units / Rail
MC74HC4051ADTR2G	TSSOP-16 (Pb-Free)	2500 Units / Tape & Reel
NLVHC4051ADTR2G*		2500 Units / Tape & Reel
NLVHC4051AMNTWG* (In Development)	QFN16 (Pb-Free)	3000 Units / Tape & Reel
		4
MC74HC4052ADG		48 Units / Rail
MC74HC4052ADR2G	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel
NLV74HC4052ADR2G*		2500 Units / Tape & Reel
MC74HC4052ADWG	SOIC-16 WIDE	48 Units / Rail
MC74HC4052ADWR2G	(Pb-Free)	1000 Units / Tape & Reel
MC74HC4052ADTG		96 Units / Rail
MC74HC4052ADTR2G	TSSOP-16	2500 Units / Tape & Reel
NLV74HC4052ADTRG*	(Pb-Free)	2500 Units / Tape & Reel
NLVHC4052ADTR2G*		2500 Units / Tape & Reel
NLVHC4052AMNTWG* (In Development)	QFN16 (Pb-Free)	3000 Units / Tape & Reel
MC74HC4053ADG	2010 10	48 Units / Rail
MC74HC4053ADR2G	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel
NLV74HC4053ADR2G*		2500 Units / Tape & Reel
MC74HC4053ADWG		48 Units / Rail
NLV74HC4053ADWRG*	SOIC-16 WIDE	1000 Units / Tape & Reel
MC74HC4053ADWR2G	(Pb-Free)	1000 Units / Tape & Reel
NLV74HC4053ADWR2G*		1000 Units / Tape & Reel
MC74HC4053ADTG		96 Units / Rail
MC74HC4053ADTR2G	TSSOP-16 (Pb-Free)	2500 Units / Tape & Reel
NLVHC4053ADTR2G*		2500 Units / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP

Capable.





ON Semiconductor and 🐽 are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries.
ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding
the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically
disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the
rights of others.

SCALE 1:1

-T- SEATING PLANE

STYLE 1:

PIN 1.

2. BASE

3.

4.

5. EMITTER

6. BASE

7.

8.

9. BASE

11.

COLLECTOR

COLLECTOR

COLLECTOR

EMITTER 10.

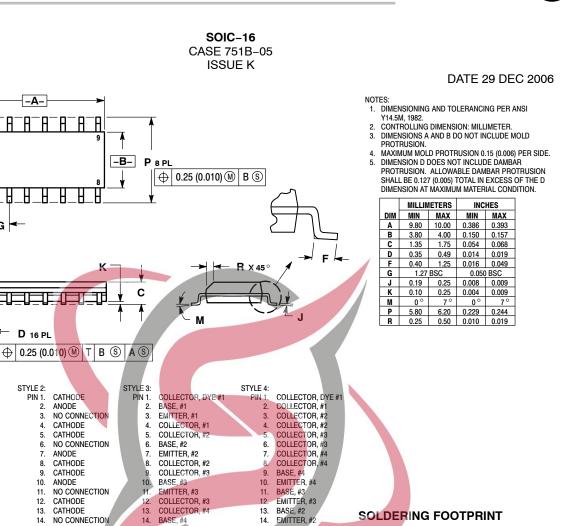
NO CONNECTION

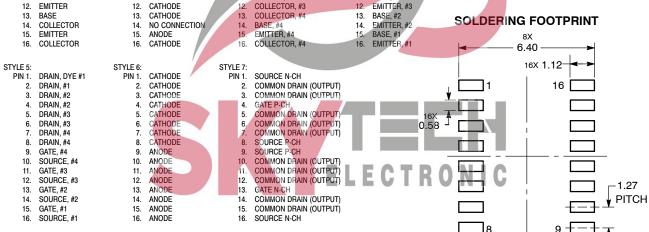
NO CONNECTION

EMITTER

H

G ◄





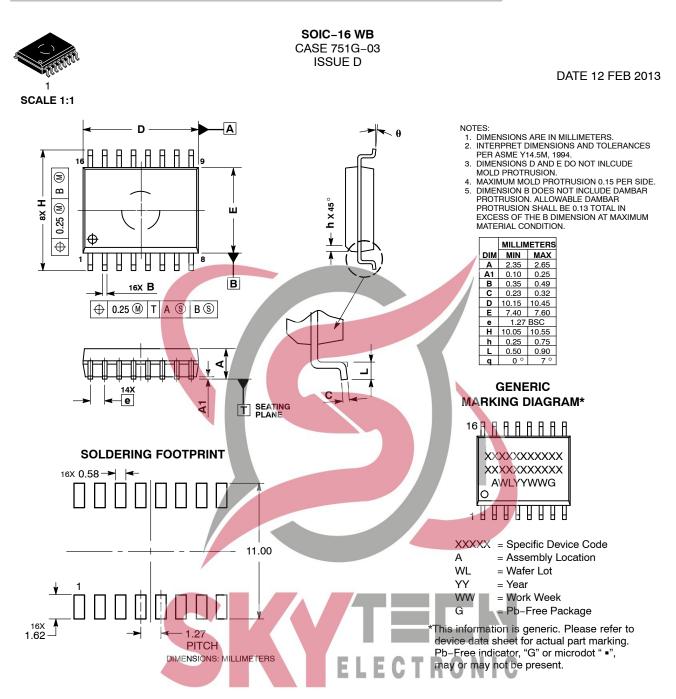
DIMENSIONS: MILLIMETERS

.

DOCUMENT NUMBER:	98ASB42566B	Electronic versions are uncontrolled except when accessed directly from the Document Reposito Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.					
DESCRIPTION:	PAGE 1 OF 1						
ON Semiconductor reserves the right the suitability of its products for any pa	ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incliental damages. ON Semiconductor does not convey any license under its patent rights nor the						

rights of others



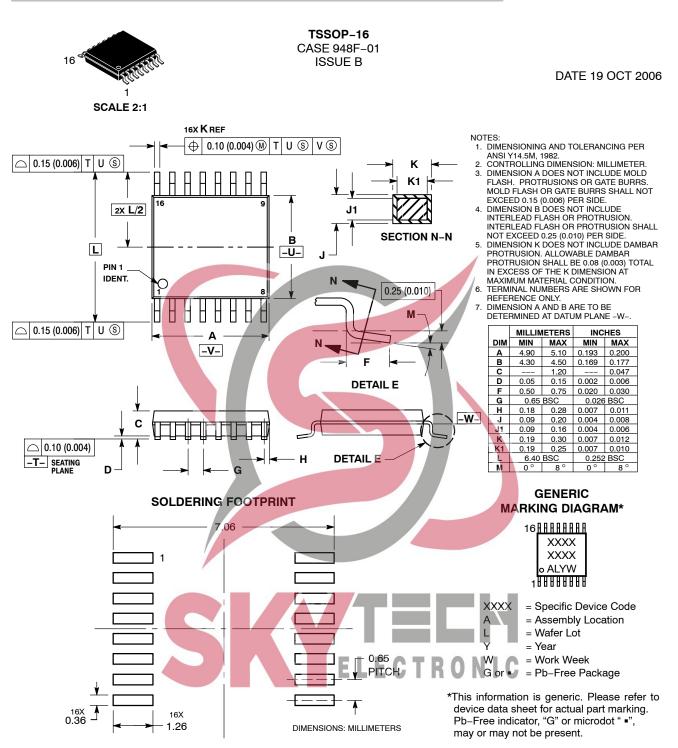


DOCUMENT NUMBER:	98ASB42567B	Electronic versions are uncontrolled except when accessed directly from the Document Reposite Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.					
DESCRIPTION:	SOIC-16 WB		PAGE 1 OF 1				
ON Semiconductor reserves the right the suitability of its products for any pa	ON Semiconductor and una are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the						

© Semiconductor Components Industries, LLC, 2019

rights of others.





DOCUMENT NUMBER:	98ASH70247A	Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.					
DESCRIPTION:	TSSOP-16	PAGE 1 OF 1					
ON Semiconductor and (1)) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding							

ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

© Semiconductor Components Industries, LLC, 2019



ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor date sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use a a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor houteds for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

ON Semiconductor Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910 Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ON Semiconductor:

MC74HC4051AD MC74HC4051ADG MC74HC4051ADR2 MC74HC4051ADR2G MC74HC4051ADT MC74HC4051ADTG MC74HC4051ADTR2 MC74HC4051ADTR2G MC74HC4051ADW MC74HC4051ADWG MC74HC4051ADWR2 MC74HC4051ADTR2 MC74HC4051AFEL MC74HC4051AFELG MC74HC4051ADW MC74HC4051ADWR2 MC74HC4052AD MC74HC4052ADG MC74HC4052ADR2 MC74HC4052ADR2G MC74HC4052ADT MC74HC4052ADTG MC74HC4052ADG MC74HC4052ADR2 MC74HC4052ADR2G MC74HC4052ADT MC74HC4052ADTG MC74HC4052ADTR2 MC74HC4052ADTR2G MC74HC4052ADW MC74HC4052ADWG MC74HC4052ADTG MC74HC4052ADWR2G MC74HC4052AF MC74HC4052AFEL MC74HC4052AFELG MC74HC4052AFG MC74HC4052AN MC74HC4052ANG MC74HC4053AD MC74HC4053ADTR2 MC74HC4053ADR2 MC74HC4053ADR2G MC74HC4053ADT MC74HC4053ADTG MC74HC4053ADTR2 MC74HC4053ADTR2G MC74HC4053ADW MC74HC4053ADWG MC74HC4053ADWR2 MC74HC4053ADTR2 MC74HC4053ADTR2G MC74HC4053AFEL MC74HC4053AFELG MC74HC4053AFG MC74HC4053ADWR2G MC74HC4053ADTR2G NLVHC4052ADTR2G NLV74HC4051ADR2G NLV74HC4053ADR2G NLVHC4051ADTR2G NLVHC4053ADTR2G NLVHC4052ADTR2G NLV74HC4051ADR2G NLV74HC4053ADR2G NLVHC4051ADTR2G NLVHC4053ADTR2G NLVHC4052ADR2G NLVHC4051ADR2G NLVHC4051ADR2G NLVHC4051ADWR2 NLV74HC4053ADTR2G NLVHC4052ADWR2G NLVHC4051ADR2G NLVHC4051ADR2G NLVHC4051ADWR2 NLV74HC4053ADTR2G NLVHC4052ADWR2G NLVHC4051ADR2G NLVHC4051ADR2G NLVHC4051ADWR2 NLV74HC4053ADTR2G NLVHC4052ADWR2G NLVHC4051ADR2G NLVHC4051ADWR2G

